

2. Specification

2-1. GSM General Specification

	GSM850	EGSM 900	DCS1800	PCS1900	WCDMA 2100	WCDMA 1900	WCDMA 900	WCDMA 850
Freq. Band[MHz] Uplink/ Downlink	824~849 869~894	880~915 925~960	1710~1785 1805~1880	1850~1910 1930~1990	1922~1977 2112~2167	1852~1907 1932~1987	880~915 925~960	824~849 869~894
ARFCN range	128~251	0~124 & 975~1023	512~885	512~810	UL: 9612~9888 DL: 10562~10838	UL: 9262~9538 DL: 9662~9938	UL: 2712~2863 DL: 2937~3088	UL: 4132~4233 DL: 4357~4458
Tx/Rx spacing	45MHz	45MHz	95MHz	80MHz	190MHz	80MHz	45MHz	45MHz
Mod. Bit rate/ Bit Period	270.833kbp s 3.692us	270.833kbp s 3.692us	270.833kbp s 3.692us	270.833kbp s 3.692us	3.84Mcps	3.84Mcps	3.84Mcps	3.84Mcps
Time Slot Period/ Frame Period	576.9us 4.615ms	576.9us 4.615ms	576.9us 4.615ms	576.9us 4.615ms	FrameLength: 10ms Slotlength: 0.667ms	FrameLength: 10ms Slotlength: 0.667ms	FrameLength: 10ms Slotlength: 0.667ms	FrameLength: 10ms Slotlength: 0.667ms
Modulation	0.3GMSK	0.3GMSK	0.3GMSK	0.3GMSK	QPSKHQPSK	QPSKHQPSK	QPSKHQPSK	QPSKHQPSK
MS Power	33dBm~5dBm	33dBm~5dBm	30dBm~0dBm	30dBm~0dBm	24dBm~ -50dBm	24dBm~ -50dBm	24dBm~ -50dBm	24dBm~ -50dBm
Power Class	5pcl ~ 19pcl	5pcl ~ 19pcl	0pcl ~ 15pcl	0pcl ~ 15pcl	3(max+24dBm)	3(max+24dBm)	3(max+24dBm)	3(max+24dBm)
Sensitivity	-102dBm	-102dBm	-100dBm	-100dBm	-106.7dBm	-106.7dBm	-106.7dBm	-106.7dBm
TDMA Mux	8	8	8	8	8	8	8	8
Cell Radius	35Km	35Km	2Km	2Km	2Km	2Km	2Km	2Km

2. Specification

2-2. GSM Tx Power Class

TX Power control level	GSM850	TX Power control level	EGSM900	TX Power control level	DCS1800	TX Power control level	PCS1900
5	33±2 dBm	5	33±2 dBm	0	30±3 dBm	0	30±3 dBm
6	31±2 dBm	6	31±2 dBm	1	28±3 dBm	1	28±3 dBm
7	29±2 dBm	7	29±2 dBm	2	26±3 dBm	2	26±3 dBm
8	27±2 dBm	8	27±2 dBm	3	24±3 dBm	3	24±3 dBm
9	25±2 dBm	9	25±2 dBm	4	22±3 dBm	4	22±3 dBm
10	23±2 dBm	10	23±2 dBm	5	20±3 dBm	5	20±3 dBm
11	21±2 dBm	11	21±2 dBm	6	18±3 dBm	6	18±3 dBm
12	19±2 dBm	12	19±2 dBm	7	16±3 dBm	7	16±3 dBm
13	17±2 dBm	13	17±2 dBm	8	14±3 dBm	8	14±3 dBm
14	15±2 dBm	14	15±2 dBm	9	12±4 dBm	9	12±4 dBm
15	13±2 dBm	15	13±2 dBm	10	10±4 dBm	10	10±4 dBm
16	11±3 dBm	16	11±3 dBm	11	8±4 dBm	11	8±4 dBm
17	9±3dBm	17	9±3dBm	12	6±4 dBm	12	6±4 dBm
18	7±3 dBm	18	7±3 dBm	13	4±4 dBm	13	4±4 dBm
19	5±3 dBm	19	5±3 dBm	14	2±5 dBm	14	2±5 dBm
				15	0±5 dBm	15	0±5 dBm

2. Specification

2-3. LTE General Specification

	LTE Band1	LTE Band3	LTE Band5	LTE Band7	LTE Band8	LTE Band20	LTE Band 40
Freq. Band[MHz] Uplink/ Downlink	1920~1980 2110~2170	1710~1785 1805~1880	824~849 869~894	2500~2570 1805~1880	880~914.9 925~959.9	832~862 791~821	2300~2400
ARFCN range	UL: 18000~1859 9 DL: 0~599	UL: 19200~1995 0 DL: 1805~1880	UL: 20400~2064 9 DL: 2400~2649	UL: 20750~2144 9 DL: 2750~3449	UL: 21450~21799 DL: 3450~3799	UL: 24150~2445 0 DL: 6150~6450	UL, DL : 2300~2400
Tx/Rx spacing	190MHz	95MHz	45MHz	120MHz	45MHZ	41MHz	-
Channel Bandwidth	60 MHz	75 MHz	25 MHz	70 MHz	1.4/3/5/10M Hz	5/10/15/20 MHz	5/10/15/20 MHz
Modulation	QPSK,16/64 QAM	QPSK,16/64 QAM	QPSK,16/64 QAM	QPSK,16/64 QAM	QPSK,16/64 QAM	QPSK,16/64 QAM	QPSK,16/64 QAM
MS Power (MPR)	-35~25.7 dBm	-35~25.7 dBm	-35~25.7 dBm	-35~25.7 dBm	-35~25.7 dBm	-35~25.7 dBm	-35~25.7 dBm
Sensitivit (QPSK) (BW 10MHz)	-94 dBm	-92 dBm	-92 dBm	-95dBm	-95dBm	-94dBm	-95dBm
Cell Radius	>5Km	>5Km	>5Km	>5Km	>5Km	>5Km	>5Km

3. Operation Instruction and Installation

Main Function

Item	Description
OS	Android V 6.0.1 (Mashmallow)
RF	2G Quad(850/900/1800/1900), WCDMA(1,5,8), LTE (1,3,5,7,8,20,40)
Battery	1,500mAh
Base Band	1.5GHz Quad
Other RF	GPS, Glonass BT4.0, USB 2.0, WIFI 802.11 b/g/n SISO
Camera	5MP FF (Main). VGA(Front)
LCD	3.97" WVGA LCD, 800 x 480
RAM	1GB LPDDR3 RAM + 8GB eMMC
Sensor	Accelerometer
Accessory	Charger: 5V, 0.7A Headset (Option)

9. Reference Abbreviate

Reference Abbreviate

- **AAC**: Advanced Audio Coding.
- **AVC** : Advanced Video Coding.
- **BER** : Bit Error Rate
- **BPSK**: Binary Phase Shift Keying
- **CA** : Conditional Access
- **CDM** : Code Division Multiplexing
- **C/I** : Carrier to Interference
- **DMB** : Digital Multimedia Broadcasting
- **EN** : European Standard
- **ES** : Elementary Stream
- **ETSI**: European Telecommunications Standards Institute
- **MPEG**: Moving Picture Experts Group
- **PN** : Pseudo-random Noise
- **PS** : Pilot Symbol
- **QPSK**: Quadrature Phase Shift Keying
- **RS** : Reed-Solomon
- **SI** : Service Information
- **TDM** : Time Division Multiplexing
- **TS** : Transport Stream

1. Safety Precautions

1-1. Repair Precaution

Before attempting any repair or detailed tuning, shield the device from RF noise or static electricity discharges.

Use only demagnetized tools that are specifically designed for small electronic repairs, as most electronic parts are sensitive to electromagnetic forces.

Use only high quality screwdrivers when servicing products. Low quality screwdrivers can easily damage the heads of screws.

Use only conductor wire of the properly gauge and insulation for low resistance, because of the low margin of error of most testing equipment.

We recommend 22-gauge twisted copper wire.

Hand-soldering is not recommended, because printed circuit boards (PCBs) can be easily damaged, even with relatively low heat. Never use a soldering iron with a power rating of more than 100 watts and use only lead-free solder with a melting point below 250°C (482°F).

Prior to disassembling the battery charger for repair, ensure that the AC power is disconnected. Always use the replacement parts that are registered in the SEC system. Third-party replacement parts may not function properly.

1. Safety Precautions

1-2. ESD(Electrostatically Sensitive Devices) Precaution

Many semiconductors and ESDs in electronic devices are particularly sensitive to static discharge and can be easily damaged by it. We recommend protecting these components with conductive anti-static bags when you store or transport them.

Always use an anti-static strap or wristband and remove electrostatic buildup or dissipate static electricity from your body before repairing ESDs.

Ensure that soldering irons have AC adapter with ground wires and that the ground wires are properly connected.

Use only desoldering tools with plastic tips to prevent static discharge.

Properly shield the work environment from accidental electrostatic discharge before opening packages containing ESDs.

The potential for static electricity discharge may be increased in low humidity environments, such as air-conditioned rooms. Increase the airflow to the working area to decrease the chance of accidental static electricity discharges.

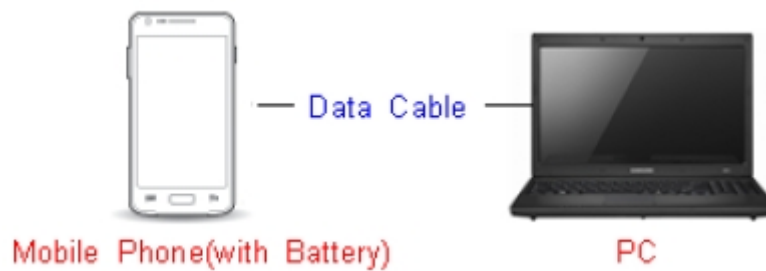
6. Level 1 Repair

6-1. S/W installation

6-1-1. Required items in order to install S/W

- Installation program: Downloader Program ([Odin3 v3.09.exe](#))
- Mobile Phone
- Data Cable
- Mobile device specific S/W: Binary files

※ Settings

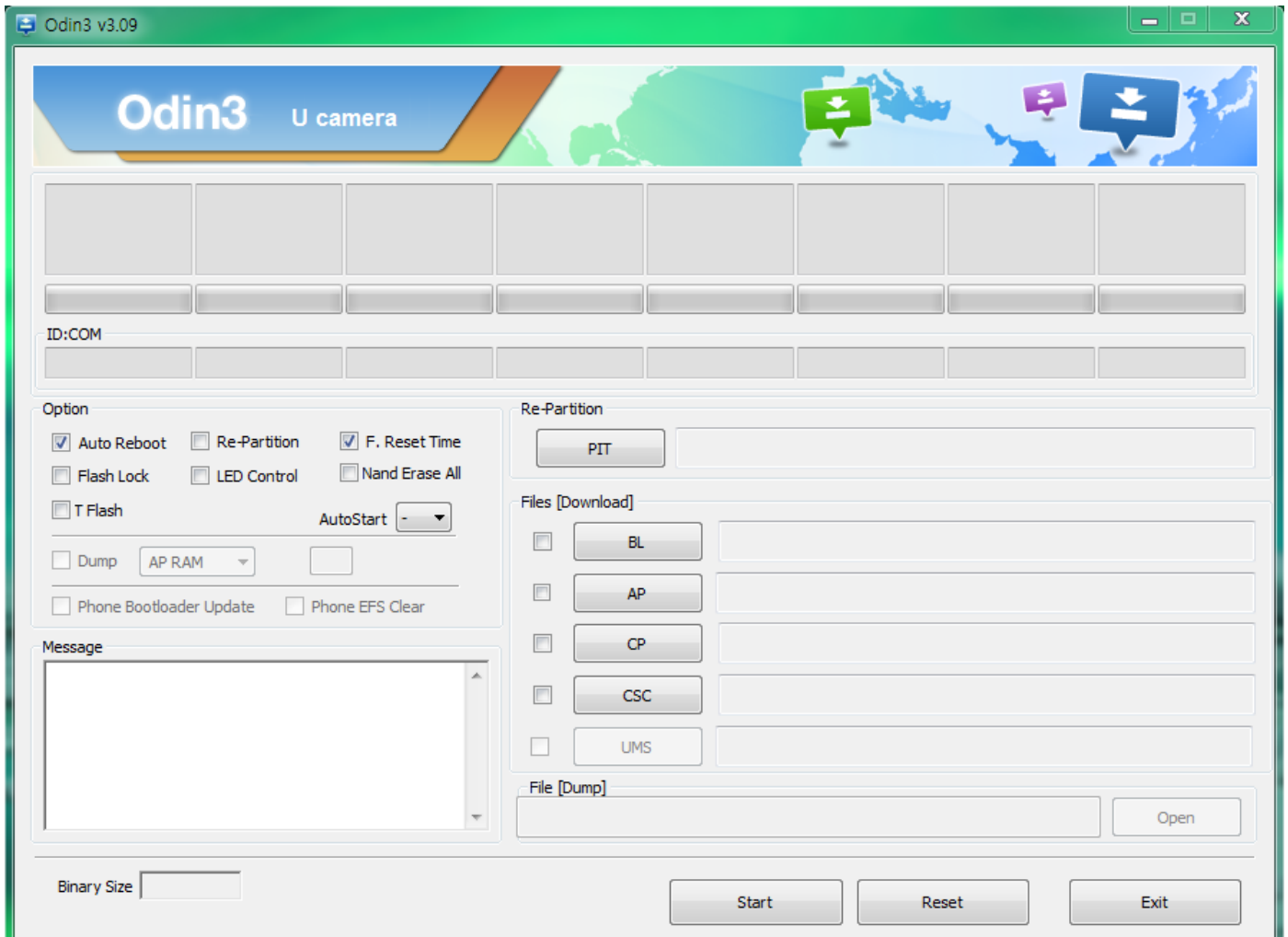


Data Cable : GH39-01711C, GH39-01710D

6. Level 1 Repair

6-1-2. S/W Installation Program (Downloader program)

- Open up the S/W Installation Program by executing the "**Odin3 v3.09.exe**"

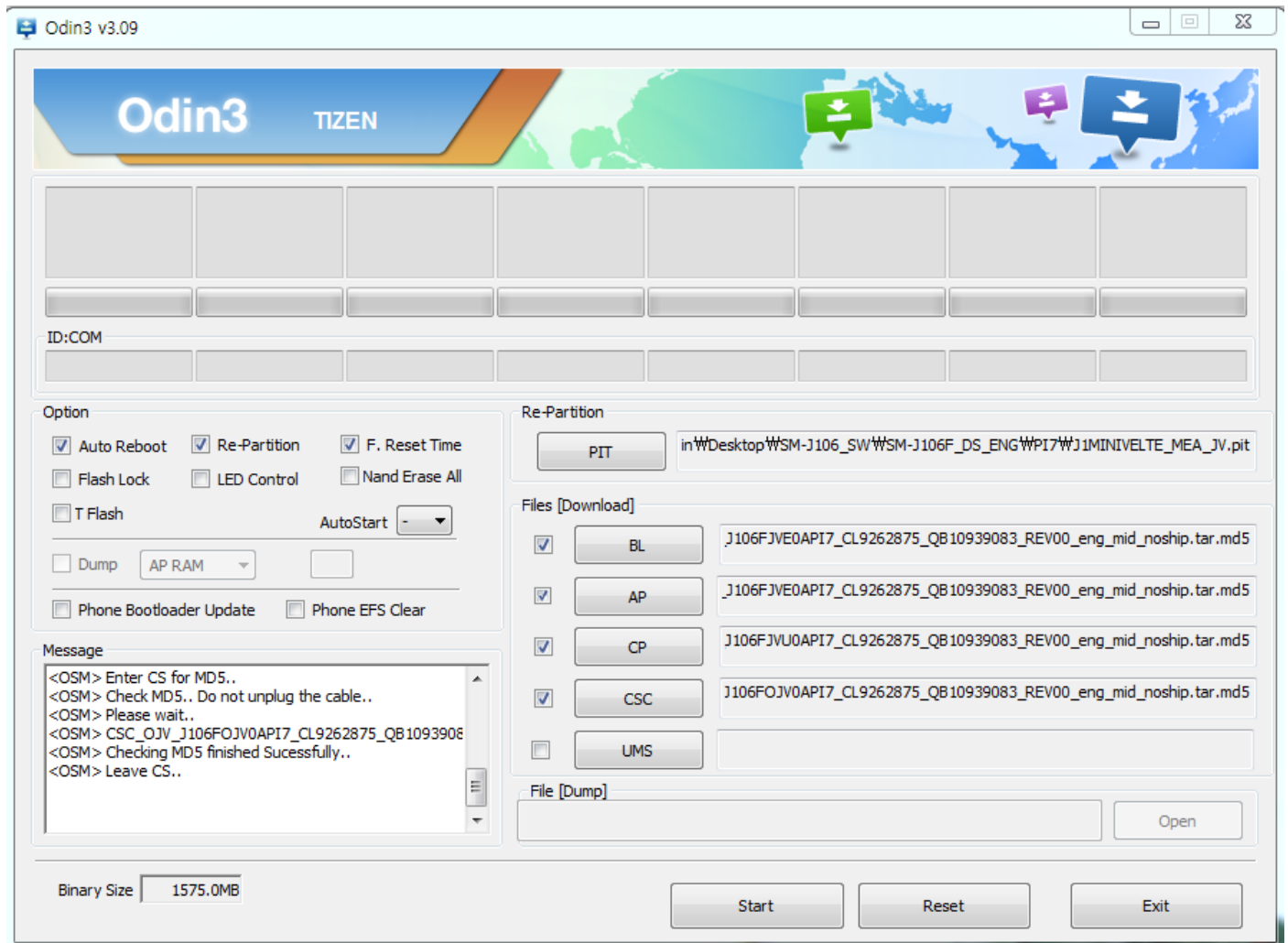


6. Level 1 Repair

1. Enable the check mark by click on the following options,

- Check Auto Reboot, Re-Partition, and F. Reset Time
- Check PIT
- Check BOOTLOADER, PDA, PHONE, and CSC Files

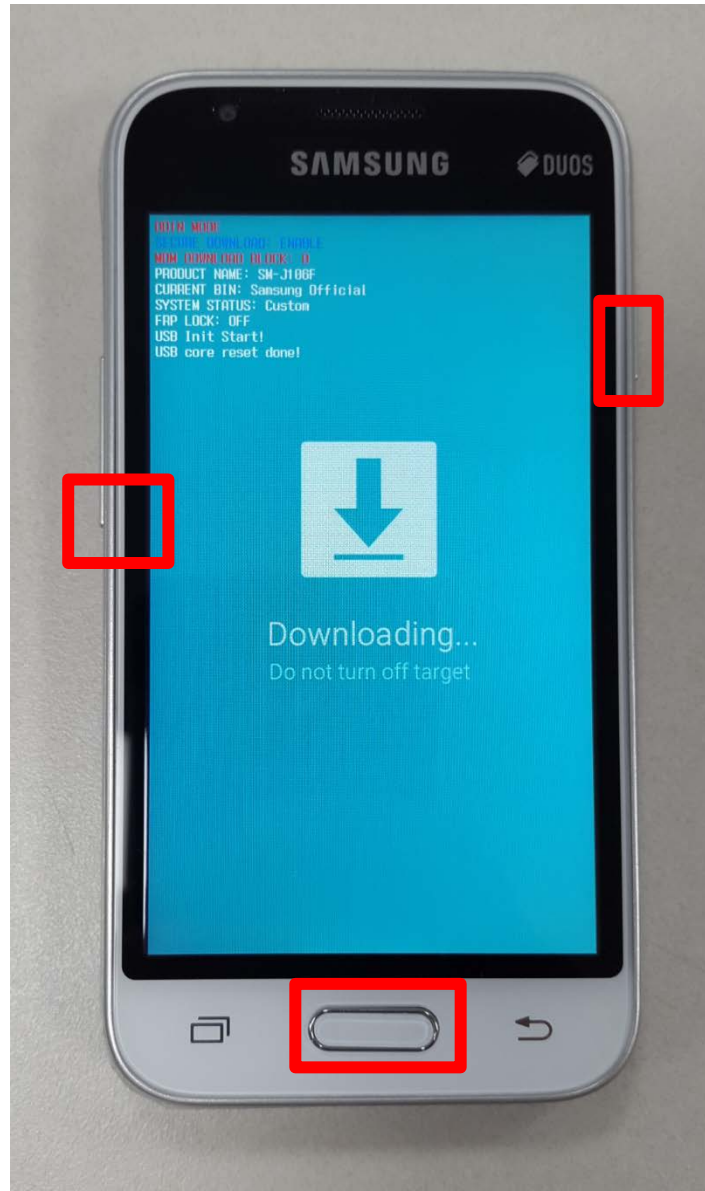
* Note : "Odin v3.09 or above" checks MD5 checksum just after file selection.



6. Level 1 Repair

2. Enter into Download Mode

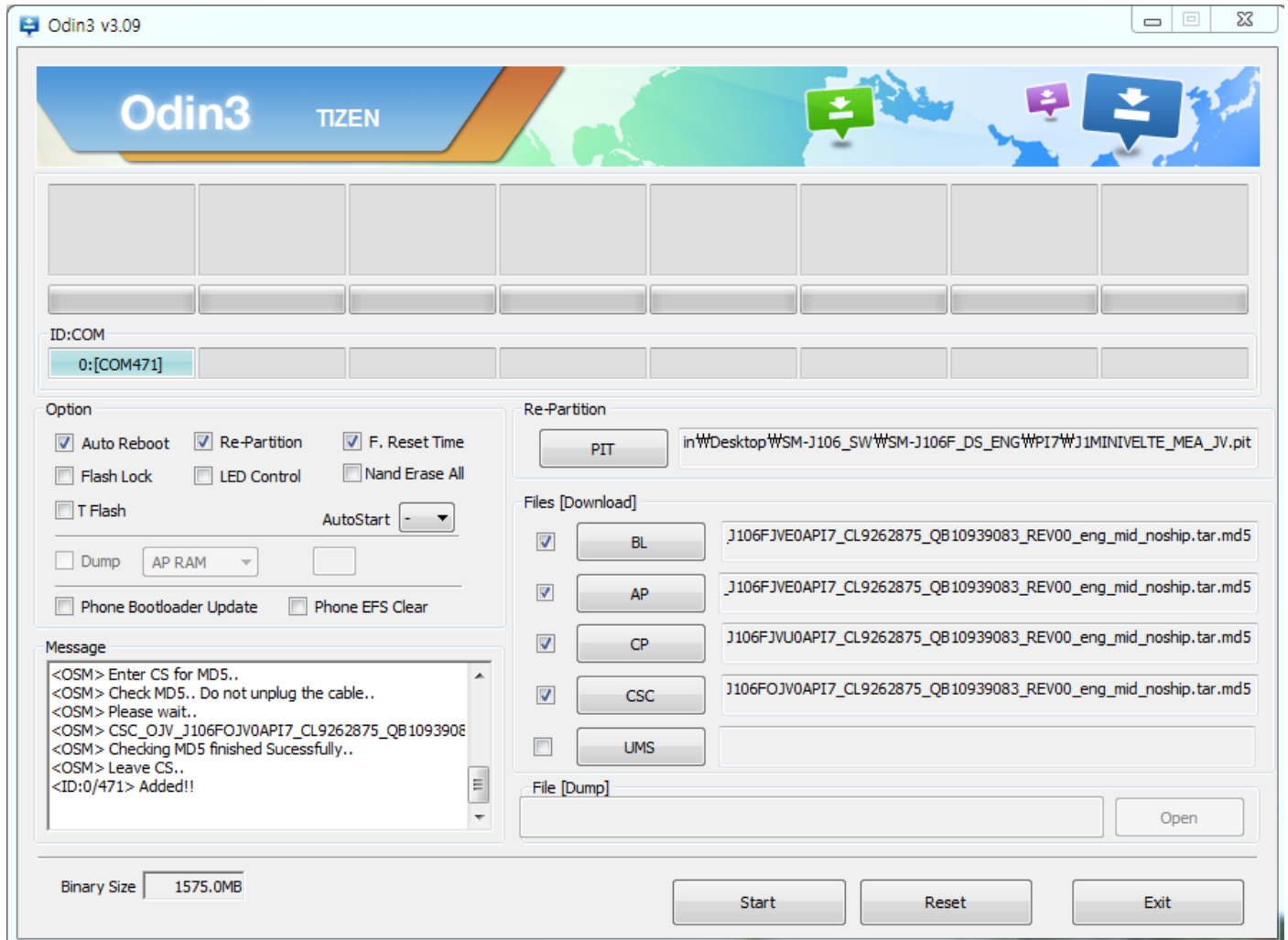
- Enter into Download Mode by pressing Volume Down button, Home button and ON/OFF Button simultaneously followed by pressing Volume up button as a direction of the phone.



6. Level 1 Repair

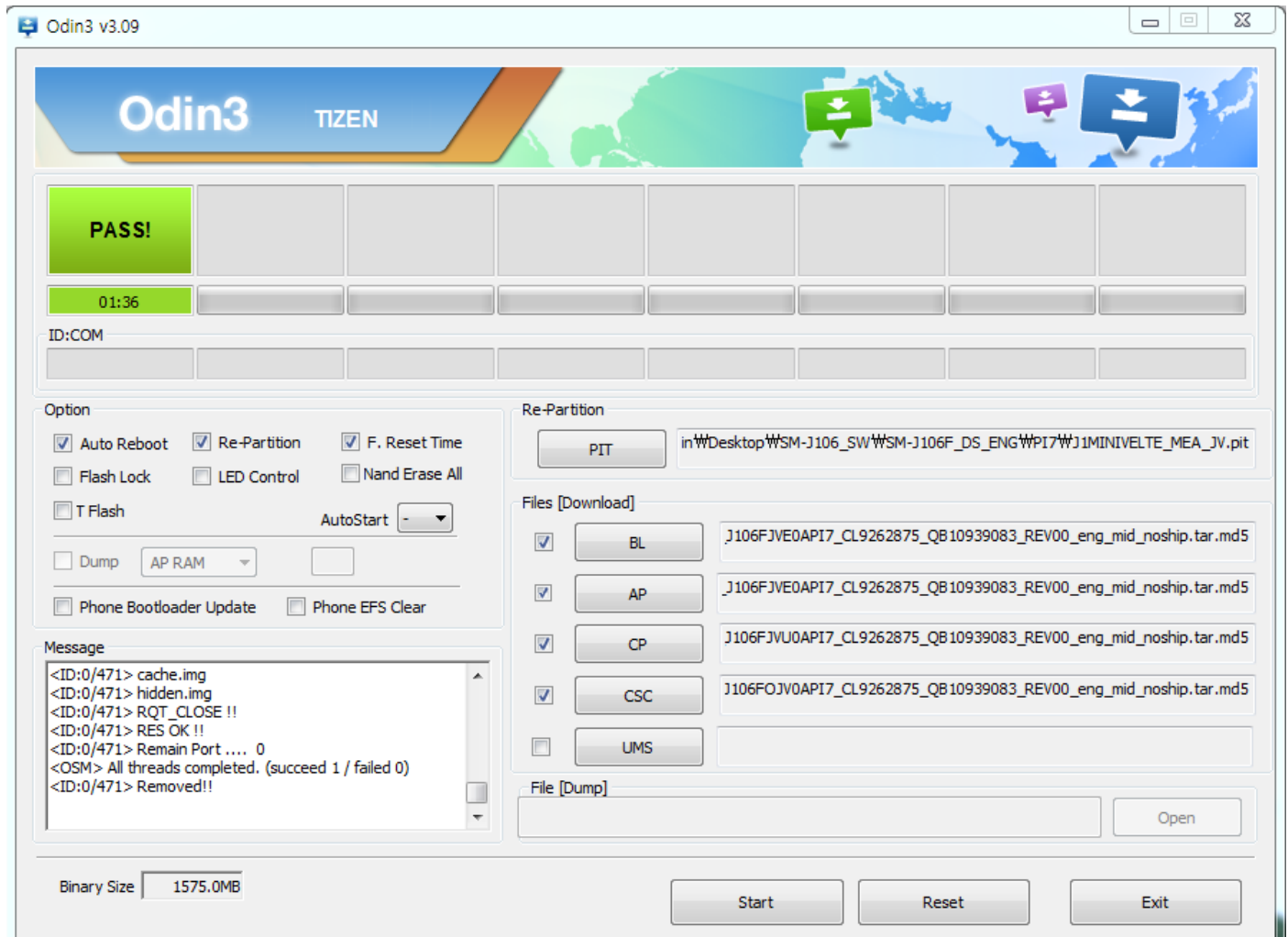
3. Connect the device to PC via Data Cable.

Make sure that the one of communication ports [ID:COM] box is highlighted in sky blue. The device is now connected with the PC and ready to download the binary files in it.



6. Level 1 Repair

4. Start downloading the binary files into the device by clicking Start button on the screen. The green colored "PASS!" sign will appear on the upper-left box if the binary files have been successfully downloaded into the device.



5. Disconnect the device from the Data cable.
6. Once the device boots up, you can check the version of the binary file or name by pressing the following code in sequence;
***#1234#**

You can perform Factory Reset by Settings → Accounts → Backup and reset

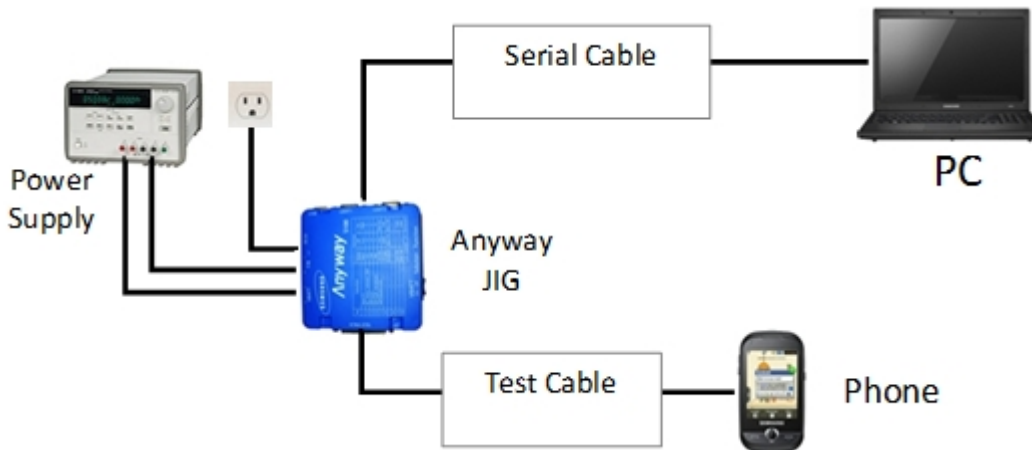
6. Level 1 Repair

6-2 IMEI writing

6-2-1 Preparation

- New IMEI writing Program has been released.
- Supported Model : Models which CAB files are uploaded on HHPsvc INI File category, instead of ini file.
- Refer to below IMEI writing procedure.

- H/W



- S/W

① Library Install	To use Daseul, library files should be installed. Refer to SVC Bulletin “(11-82) Daseul (New IMEI writing Program) Library Install guide_rev1.0”
② Launcher	DASEUL_SVC_Launcher_v3_0_25 or higher -Uploaded on HHPsvc Notice
③ Runtime File	1. DASEUL_Runtime_Ver_3.1.139.0.CAB or higher -Uploaded on HHPsvc Notice 2. Make ‘ModelName’ folder at the same position with launcher & Runtime file.
④ Model File	Copy Model File under the ‘Model Name’ folder

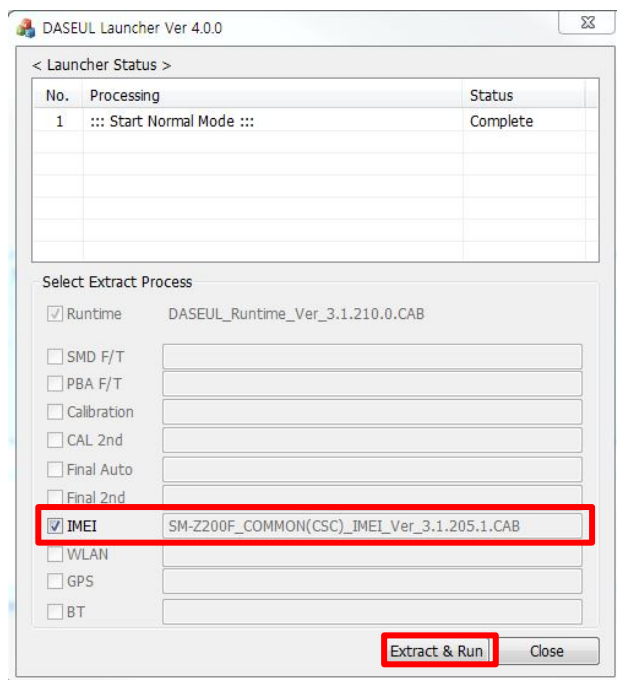
6. Level 1 Repair

6-2-2 IMEI writing Process

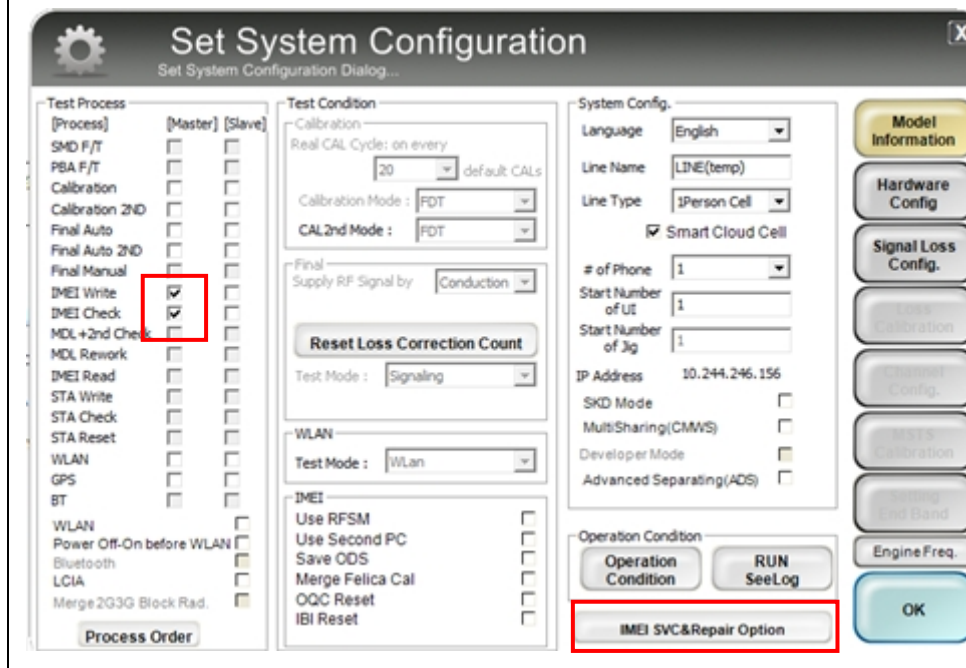
1. Run DASEUL_SVC_Launcher_v3.0.10.exe

 DASEUL_Launcher_v3.0.27.exe

2. Select IMEI and then Extract & Run

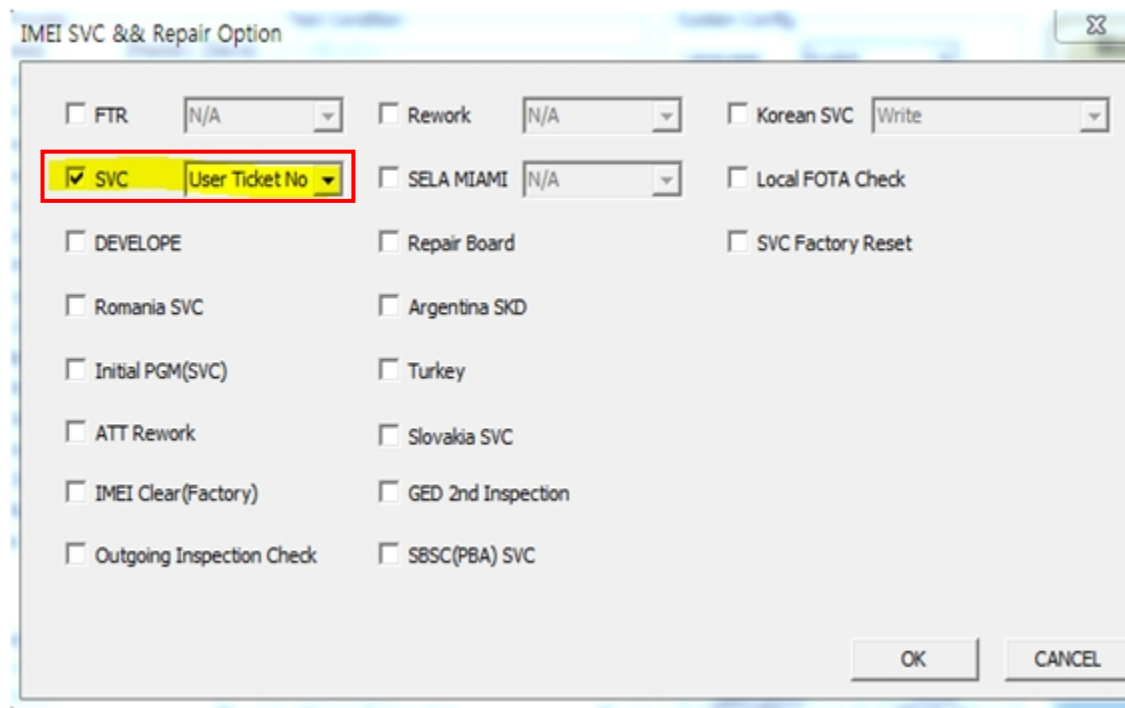


3. Check 'IMEI Write / IMEI Check', and click 'IMEI SVC & Repair Option'



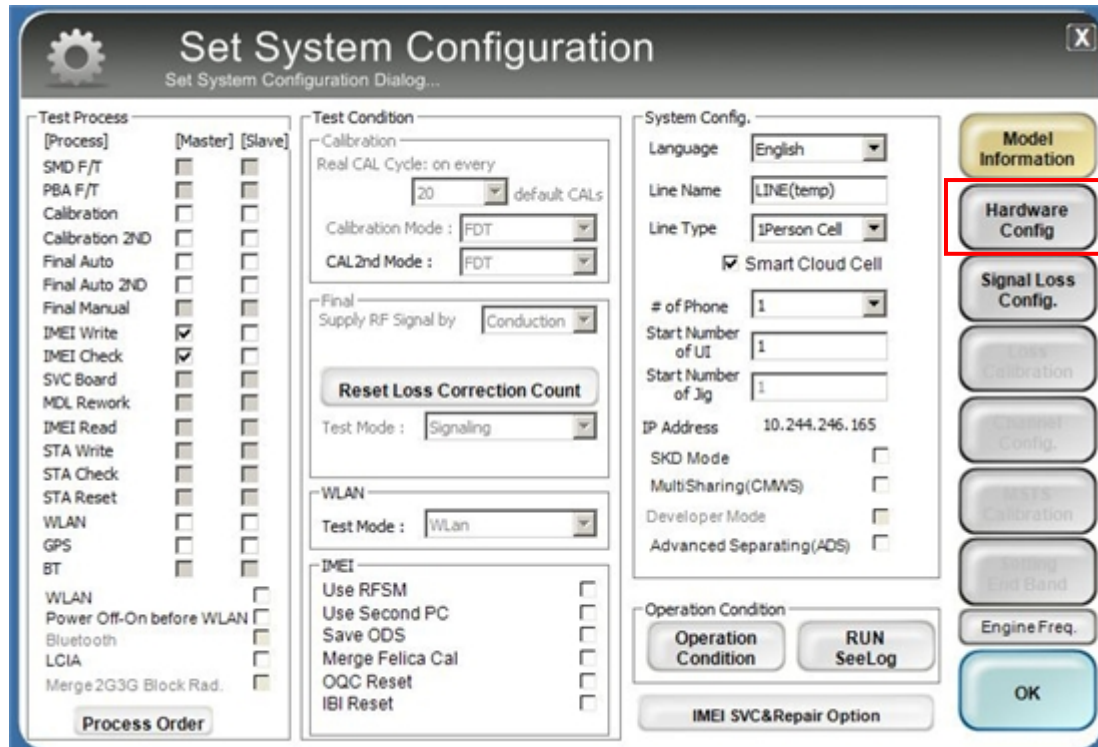
6. Level 1 Repair

4. Check 'SVC , User Ticket No' and click OK



The dialog box titled "IMEI SVC && Repair Option" contains various checkboxes and dropdown menus. The "SVC" checkbox is checked and highlighted with a red box, and its dropdown menu is set to "User Ticket No". Other options include FTR, Rework, Korean SVC, Sela Miami, Local FOTA Check, DEVELOPE, Repair Board, SVC Factory Reset, Romania SVC, Argentina SKD, Initial PGM(SVC), Turkey, ATT Rework, Slovakia SVC, IMEI Clear(Factory), GED 2nd Inspection, Outgoing Inspection Check, and SBSC(PBA) SVC. The "OK" and "CANCEL" buttons are at the bottom right.

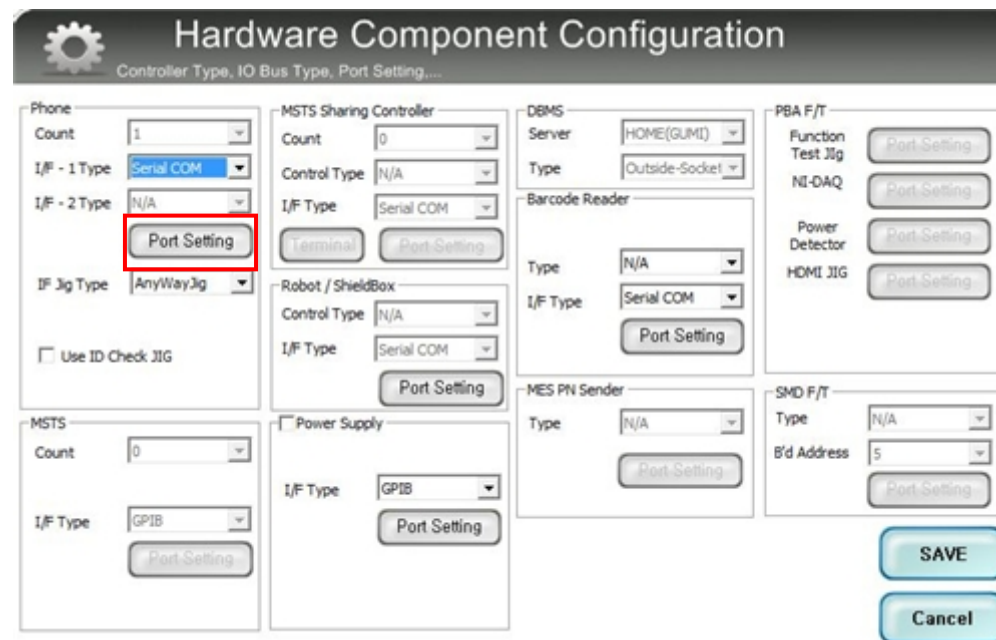
5. Click 'Hardware Config'



The "Set System Configuration" dialog box has a sidebar with a list of test processes. The "Hardware Config" button is highlighted with a red box. The main area contains sections for "Test Condition" (Calibration, Final, WLAN, IMEI), "System Config." (Language, Line Name, Line Type, Smart Cloud Cell, # of Phone, Start Number, IP Address, SKD Mode, MultiSharing, Developer Mode, Advanced Separating), and "Operation Condition". The "OK" button is at the bottom right.

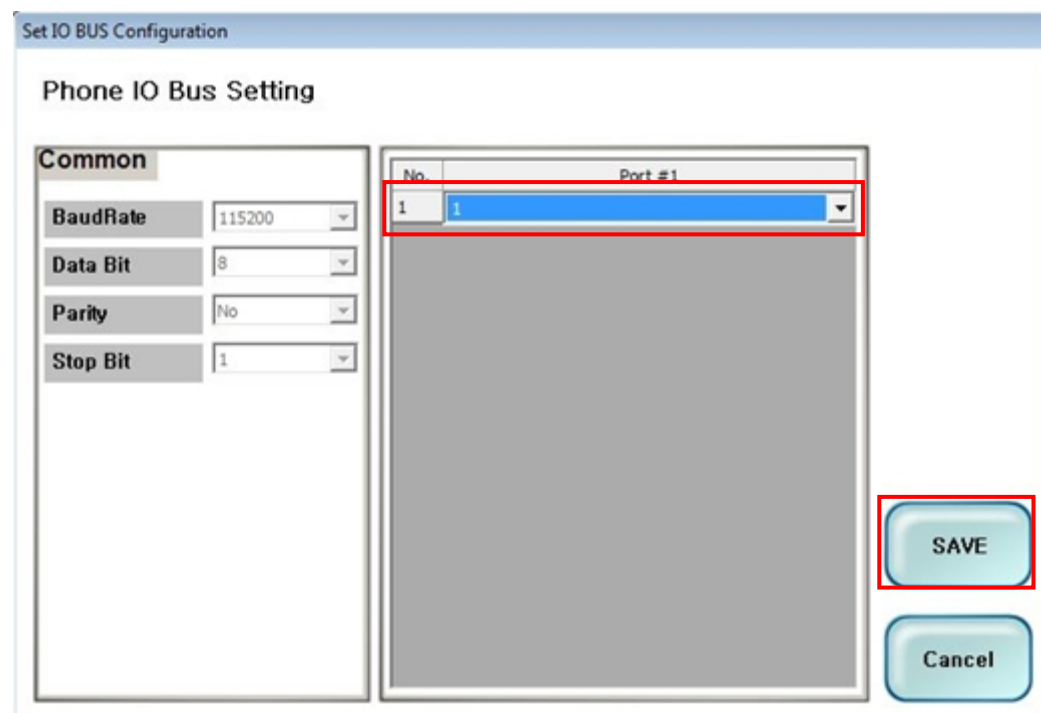
6. Level 1 Repair

6. Click 'Port Setting'



The screenshot shows the 'Hardware Component Configuration' window. The 'Phone' section has a 'Port Setting' button highlighted with a red box. Other sections include 'MSTS Sharing Controller', 'DBMS', 'Barcode Reader', 'MES PN Sender', 'SMD F/T', 'PBA F/T', 'MSTS', and 'Power Supply', each with various configuration options and 'Port Setting' buttons. At the bottom right are 'SAVE' and 'Cancel' buttons.

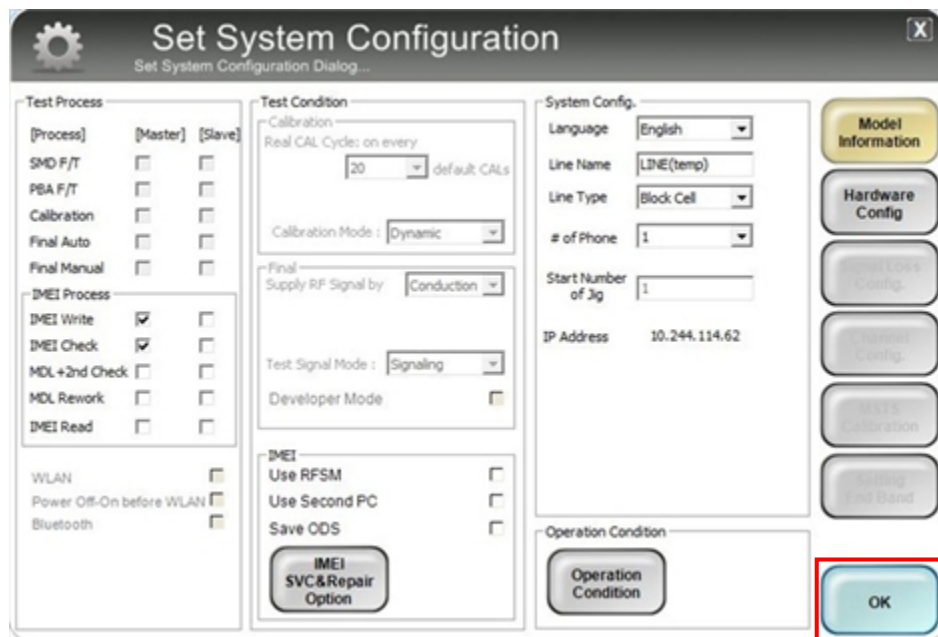
7. Select Port Number and SAVE



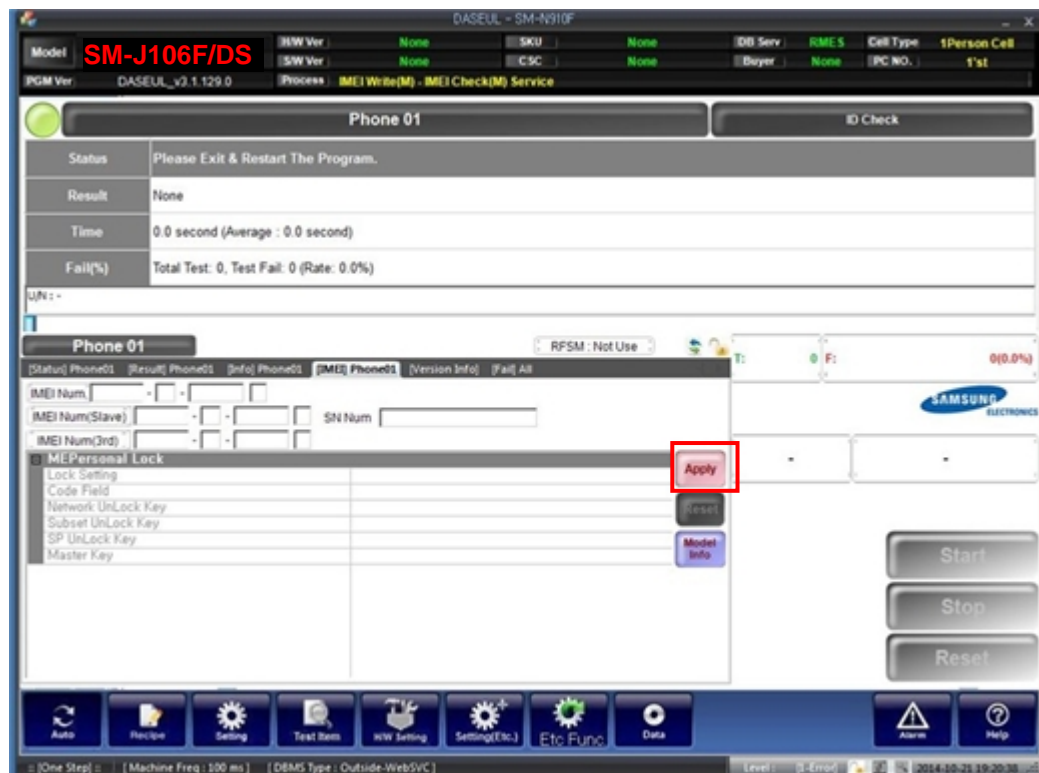
The screenshot shows the 'Set IO BUS Configuration' window. The 'Phone IO Bus Setting' section has a 'Common' tab. The 'BaudRate' is set to 115200, 'Data Bit' to 8, 'Parity' to No, and 'Stop Bit' to 1. The 'Port #1' dropdown menu is highlighted with a red box and shows the value '1'. At the bottom right are 'SAVE' and 'Cancel' buttons, with the 'SAVE' button highlighted by a red box.

6. Level 1 Repair

8. Click OK to proceed



9. Click Model Info and OK when pop-up shows



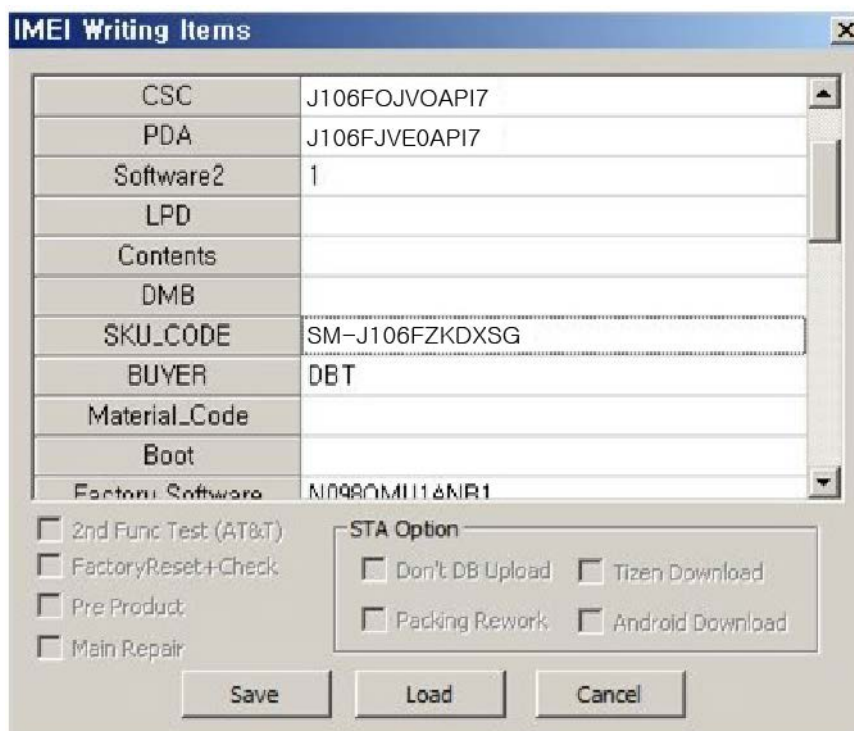
6. Level 1 Repair

10. Click OK



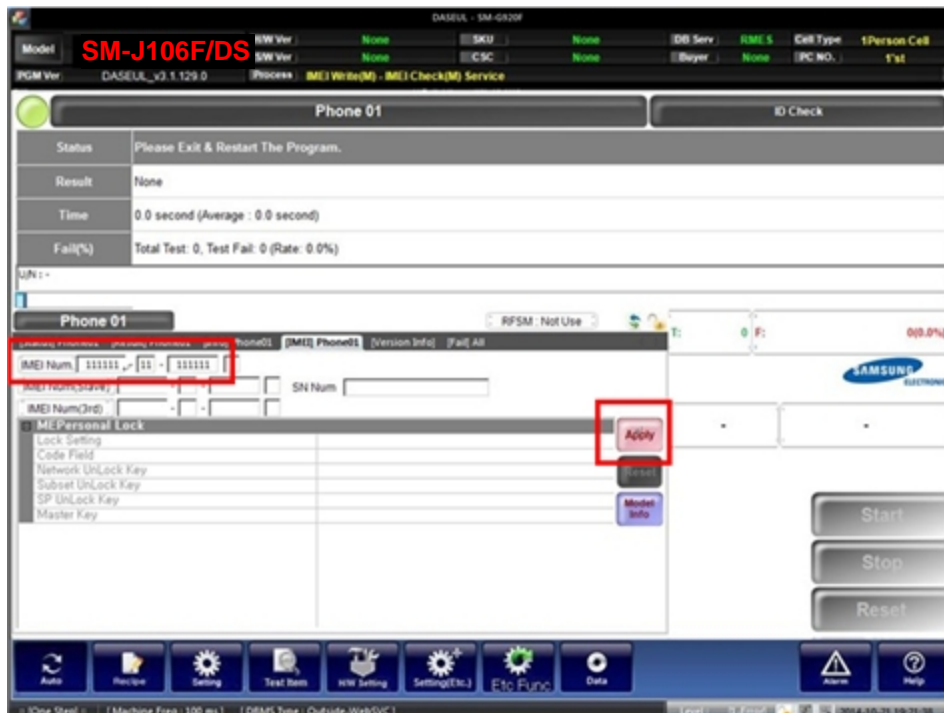
11. Input SKU_CODE and BUYER, then click Save button.

※ Refer to HHPsvc→IMEI Review to check SKU Code and buyer

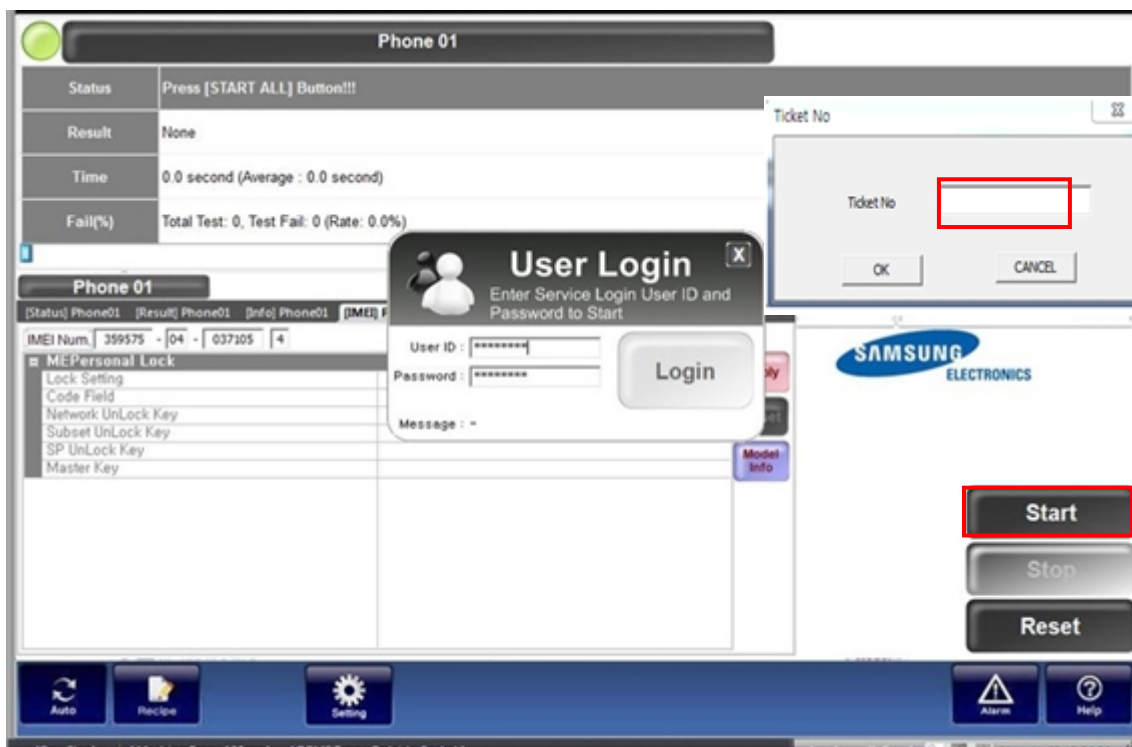


6. Level 1 Repair

12. Input IMEI Number and click Apply



13. ① Click Start, and input IMEI writing ID and Password → ② input Ticket No

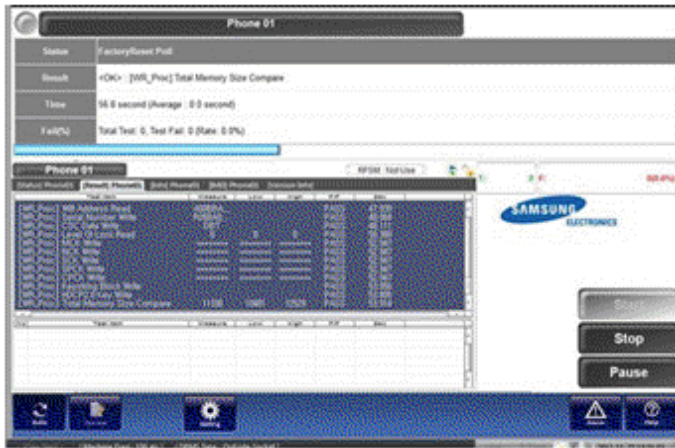


6. Level 1 Repair

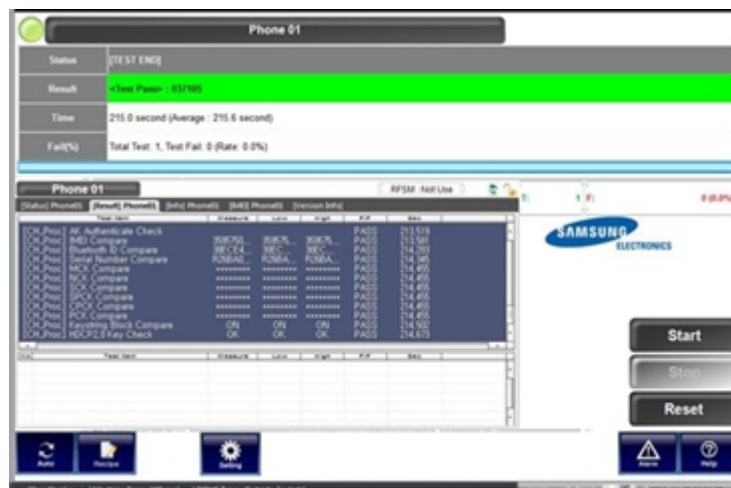
14. Connect the phone to Anyway JIG

※ When you connect the phone, the phone should be turned off.
After connecting the phone, the phone will be booted automatically.

15. IMEI Writing Proceeding



16. IMEI Writing Success



6. Level 1 Repair

6-3. RF Calibration

6-3-1. Required items in order to calibrate RF

- Installation program: RF Calibration Program
- Daseul_Launcher_vx.x.xx.exe
- Daseul_CAL_ALL_Runtime_x.x.xxx.x.CAB
- Model File (SM-XXXXXX_OPEN_CALIBRATION_VER_x.x.xxx.xx.CAB)

※ It is required to use the latest program.

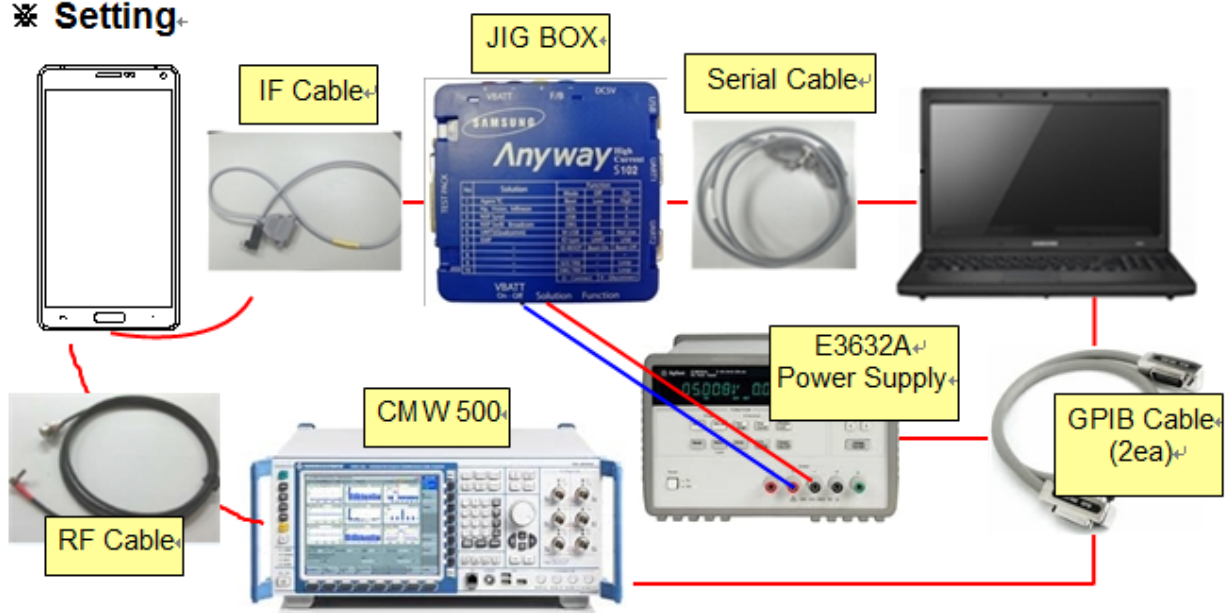
- Mobile Phone
- E3632A Power Supply
- JIG BOX (GH81-11888A)
- UART Serial Cable
- R&S CMW500
- GPIB Cable (2ea)
- Adapter (GH81-11888K)

• Table of test cables

IF Cable	GH81-10631A 11 pin	GH81-10952A 7 pin (New)	GH81-11171A 7 pin (Old)	
RF Cable	GH81-11962M 1.2T (New) 	GH81-11962G 1.35T, 1750mm 	GH81-11962C 1.6T, 400mm 	GH81-11962F 1.6T, 1700mm 
	GH81-08798A 			
4 Port Divider	GH81-11962A Divider 	GH81-11962B Divider Cable 	GH81-11962E 50Ω Terminator 	

6. Level 1 Repair






※ Setting



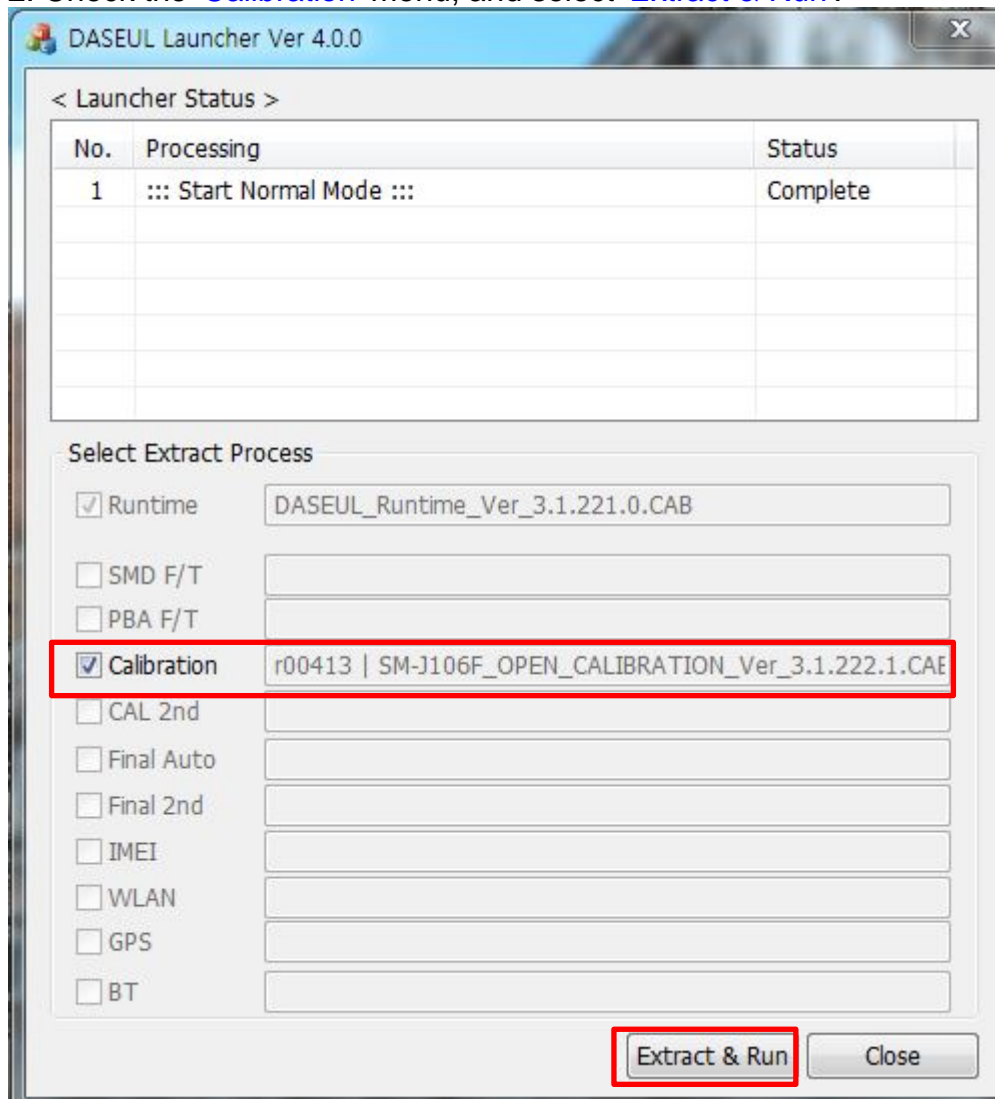
6. Level 1 Repair

6-3-2. RF Calibration Program

1. Run the RF Calibration Program Launcher, 'DASEUL_Launcher_vx.x.xx.exe'.

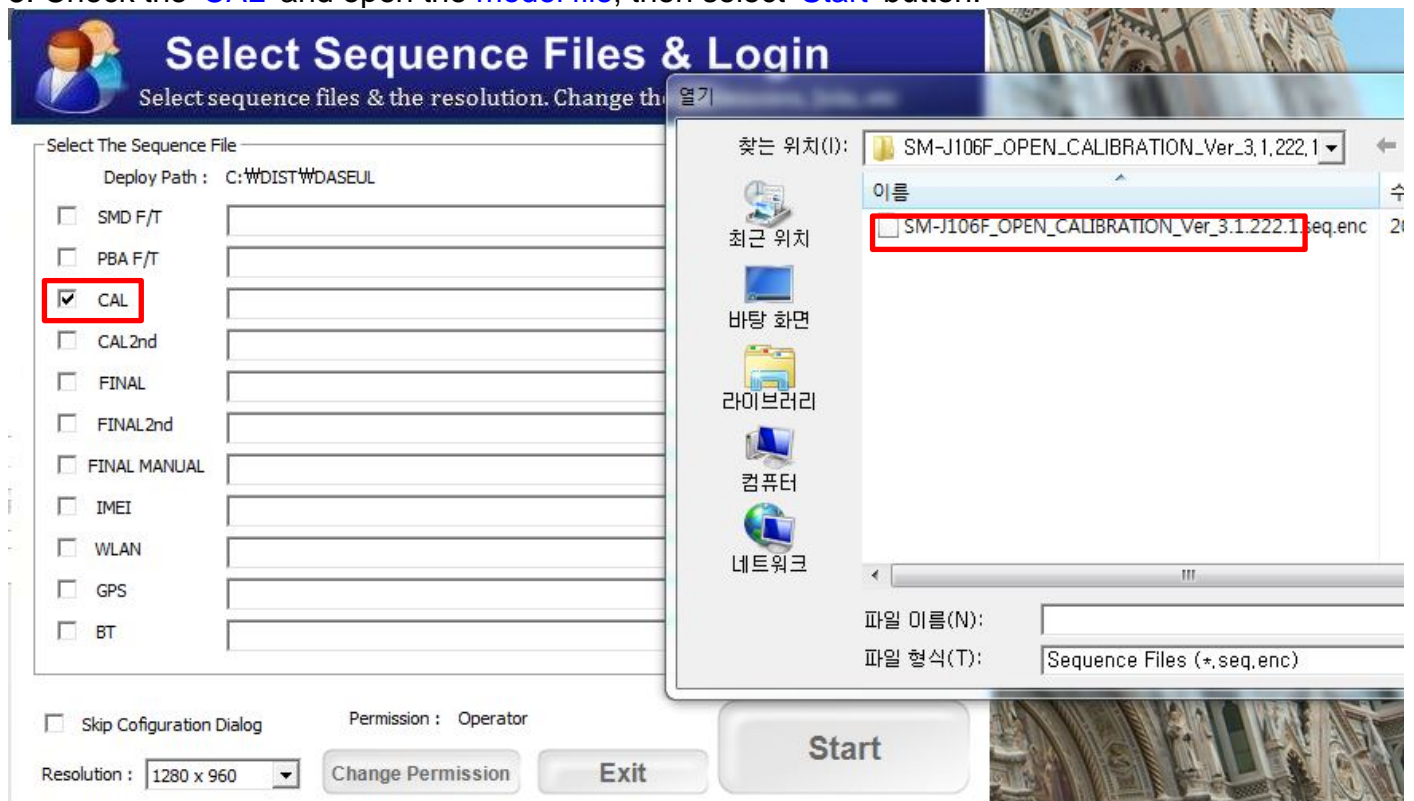
 DASEUL_CAL_ALL_Component_r00413.CAB
 DASEUL_CAL_ALL_Runtime_3.1.221.0_r00413.CAB
 DASEUL_Launcher_v4.0.0.exe
 DASEUL_Runtime_Ver_3.1.221.0.CAB
 SM-J106F_OPEN_CALIBRATION_Ver_3.1.222.1.CAB

2. Check the 'Calibration' menu, and select 'Extract & Run'.



6. Level 1 Repair

3. Check the 'CAL' and open the [model file](#), then select 'Start' button.



6. Level 1 Repair

4. Change the Line Type to 'Block Cell' and disable 'Smart Cloud Cell'.

Set System Configuration
Set System Configuration Dialog...

Test Process

[Process]	[Master]	[Slave]
SMD F/T	<input type="checkbox"/>	<input type="checkbox"/>
PBA F/T	<input type="checkbox"/>	<input type="checkbox"/>
Calibration	<input checked="" type="checkbox"/>	<input type="checkbox"/>
Calibration 2ND	<input type="checkbox"/>	<input type="checkbox"/>
Final Auto	<input type="checkbox"/>	<input type="checkbox"/>
Final Auto 2ND	<input type="checkbox"/>	<input type="checkbox"/>
Final Manual	<input type="checkbox"/>	<input type="checkbox"/>
IMEI Write	<input type="checkbox"/>	<input type="checkbox"/>
IMEI Check	<input type="checkbox"/>	<input type="checkbox"/>
MDL+2nd Check	<input type="checkbox"/>	<input type="checkbox"/>
MDL Rework	<input type="checkbox"/>	<input type="checkbox"/>
IMEI Read	<input type="checkbox"/>	<input type="checkbox"/>
STA Write	<input type="checkbox"/>	<input type="checkbox"/>
STA Check	<input type="checkbox"/>	<input type="checkbox"/>
STA Reset	<input type="checkbox"/>	<input type="checkbox"/>
WLAN	<input type="checkbox"/>	<input type="checkbox"/>
GPS	<input type="checkbox"/>	<input type="checkbox"/>
BT	<input type="checkbox"/>	<input type="checkbox"/>
WLAN	<input type="checkbox"/>	<input type="checkbox"/>
Power Off-On before WLAN	<input type="checkbox"/>	<input type="checkbox"/>
Bluetooth	<input type="checkbox"/>	<input type="checkbox"/>
LCIA	<input type="checkbox"/>	<input type="checkbox"/>
Merge 2G3G Block Rad.	<input type="checkbox"/>	<input type="checkbox"/>

Test Condition

Calibration
Real CAL Cycle: on every default CALs

Calibration Mode :

CAL2nd Mode :

Final
Supply RF Signal by

- Loss Cal ☐

Reset Loss Correction Count

Test Mode :

WLAN
Test Mode :

IMEI
Use RFSM ☐
Use Second PC ☐
Save ODS ☐
Merge Felica Cal ☐
OQC Reset ☐
IBI Reset ☐

System Config.

Language

Line Name

Line Type

☐ Smart Cloud Cell

of Phone

Start Number of UI

Start Number of Jig

IP Address

SKD Mode ☐

MultiSharing(CMWS) ☐

Developer Mode ☐

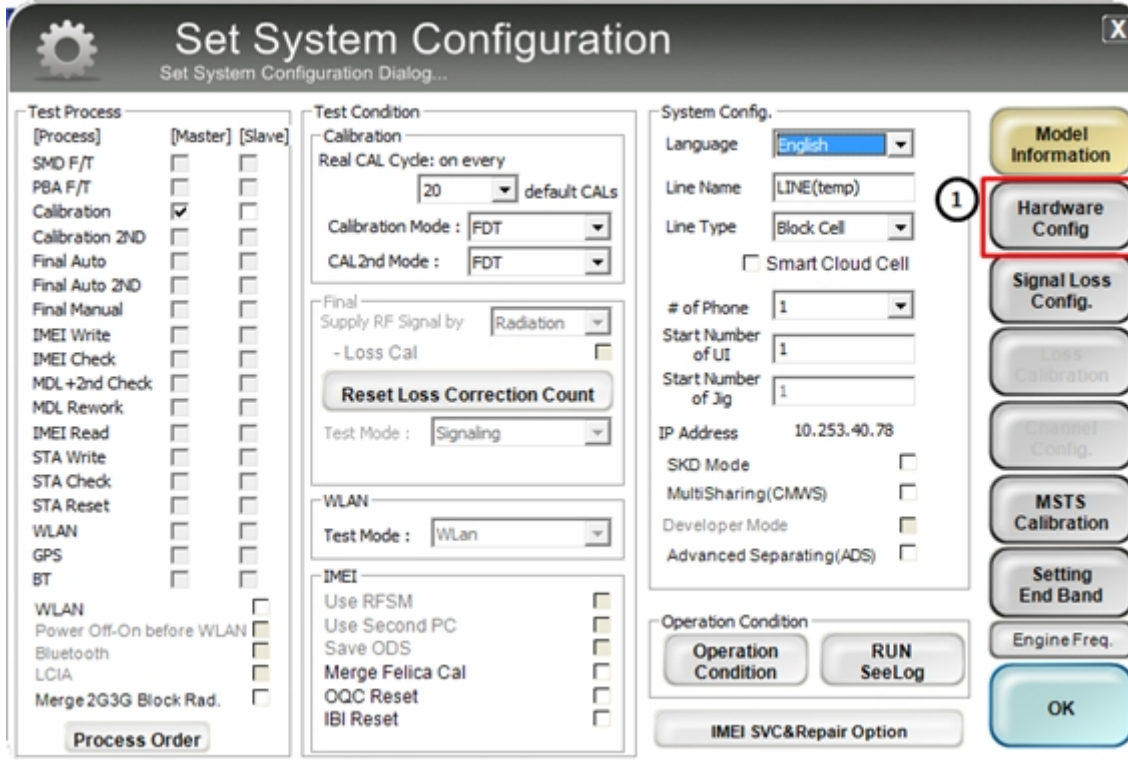
Advanced Separating(ADS) ☐

Operation Condition

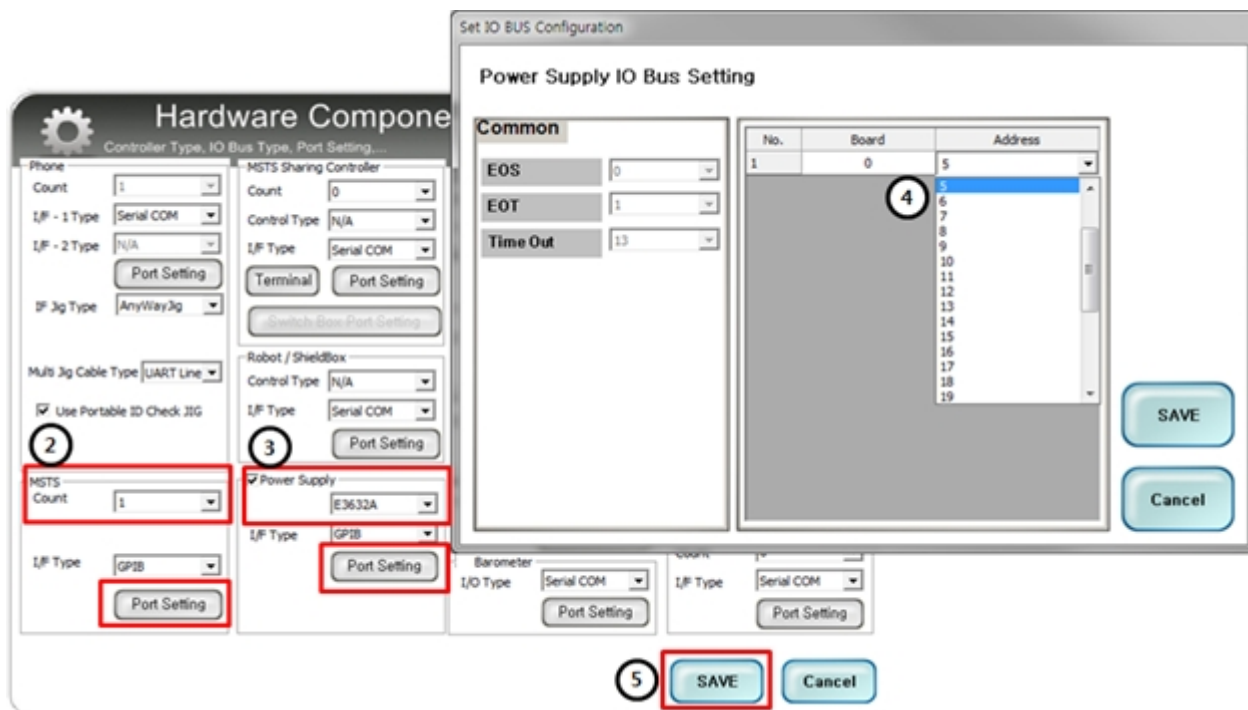
Model Information

6. Level 1 Repair

5. Set the GPIB address of MSTs(CMW500) and Power Supply(E3632A) to enter 'Hardware Config' and 'Save'. (Check the GPIB address of equipments in advance)



The 'Set System Configuration' dialog box is shown. It has several tabs: 'Test Process', 'Test Condition', 'System Config.', and 'Model Information'. The 'Hardware Config' button is highlighted with a red box and a circled '1'. The 'Test Process' tab is active, showing a list of test processes with checkboxes for 'Master' and 'Slave'. The 'Test Condition' tab shows calibration settings. The 'System Config.' tab shows language, line name, line type, and other system parameters. The 'Model Information' tab shows model information.



The 'Hardware Component' dialog box is shown, with the 'MSTs' section highlighted by a red box and a circled '2'. The 'Power Supply' section is also highlighted by a red box and a circled '3'. The 'Power Supply IO Bus Setting' dialog box is shown, with the 'Common' tab active. The 'EOS' and 'EOT' settings are highlighted by a red box and a circled '4'. The 'SAVE' button is highlighted by a red box and a circled '5'.

6. Press 'OK' to start RF Calibration after completing all settings.

